

## Description

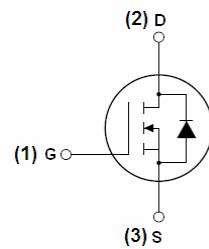
The VST13N044 uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

## General Features

- $V_{DS} = 135V, I_D = 180A$
- $R_{DS(ON)} < 5m\Omega @ V_{GS}=10V$
- Excellent gate charge  $\times R_{DS(on)}$  product
- Very low on-resistance  $R_{DS(on)}$
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

## Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



TO-247

Schematic Diagram

## Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VST13N044-T7	VST13N044	TO-247	-	-	-

## Absolute Maximum Ratings ( $T_c=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	135	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous	$I_D$	180	A
Drain Current-Continuous( $T_c=100^\circ C$ )	$I_D (100^\circ C)$	127	A
Pulsed Drain Current	$I_{DM}$	720	A
Maximum Power Dissipation	$P_D$	520	W
Derating factor		3.47	W/°C
Single pulse avalanche energy <sup>(Note 5)</sup>	$E_{AS}$	3400	mJ
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 To 175	°C

## Thermal Characteristic

Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	$R_{\theta JC}$	0.29	°C/W
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**Electrical Characteristics ( $T_c=25^\circ\text{C}$  unless otherwise noted)**

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$	135	-	-	V
Zero Gate Voltage Drain Current	$\text{I}_{\text{DSS}}$	$\text{V}_{\text{DS}}=135\text{V}, \text{V}_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
Gate-Body Leakage Current	$\text{I}_{\text{GSS}}$	$\text{V}_{\text{GS}}=\pm20\text{V}, \text{V}_{\text{DS}}=0\text{V}$	-	-	$\pm100$	nA
<b>On Characteristics</b> (Note 3)						
Gate Threshold Voltage	$\text{V}_{\text{GS(th)}}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\mu\text{A}$	3	3.9	5	V
Drain-Source On-State Resistance	$\text{R}_{\text{DS(ON)}}$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=100\text{A}$	-	4.4	5	$\text{m}\Omega$
Forward Transconductance	$\text{g}_{\text{FS}}$	$\text{V}_{\text{DS}}=10\text{V}, \text{I}_D=100\text{A}$	-	150	-	S
<b>Dynamic Characteristics</b> (Note4)						
Input Capacitance	$\text{C}_{\text{iss}}$	$\text{V}_{\text{DS}}=75\text{V}, \text{V}_{\text{GS}}=0\text{V},$ $F=1.0\text{MHz}$	-	19500	-	PF
Output Capacitance	$\text{C}_{\text{oss}}$		-	1100	-	PF
Reverse Transfer Capacitance	$\text{C}_{\text{rss}}$		-	110	-	PF
<b>Switching Characteristics</b> (Note 4)						
Turn-on Delay Time	$t_{\text{d(on)}}$	$\text{V}_{\text{DD}}=75\text{V}, \text{I}_D=100\text{A}$ $\text{V}_{\text{GS}}=10\text{V}, \text{R}_G=1.8\Omega$	-	-	-	nS
Turn-on Rise Time	$t_r$		-	-	-	nS
Turn-Off Delay Time	$t_{\text{d(off)}}$		-	-	-	nS
Turn-Off Fall Time	$t_f$		-	-	-	nS
Total Gate Charge	$\text{Q}_g$	$\text{V}_{\text{DS}}=75\text{V}, \text{I}_D=100\text{A},$ $\text{V}_{\text{GS}}=10\text{V}$	-	314	-	nC
Gate-Source Charge	$\text{Q}_{\text{gs}}$		-	115	-	nC
Gate-Drain Charge	$\text{Q}_{\text{gd}}$		-	70	-	nC
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage (Note 3)	$\text{V}_{\text{SD}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_F=100\text{A}$	-		1.2	V
Diode Forward Current (Note 2)	$\text{I}_s$	$\text{T}_J = 25^\circ\text{C}, \text{I}_F = \text{I}_s$ $d\text{I}/dt = 100\text{A}/\mu\text{s}$ (Note3)	-	-	180	A
Reverse Recovery Time	$t_{\text{rr}}$		-	155	-	nS
Reverse Recovery Charge	$\text{Q}_{\text{rr}}$		-	436	-	nC

**Notes:**

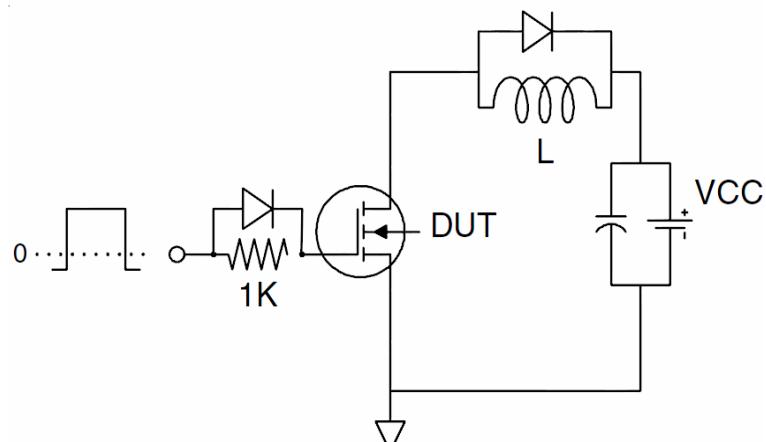
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production
5. EAS condition :  $\text{T}_J=25^\circ\text{C}, \text{V}_{\text{DD}}=50\text{V}, \text{V}_G=10\text{V}, \text{L}=0.5\text{mH}, \text{R}_g=25\Omega$

## Test Circuit

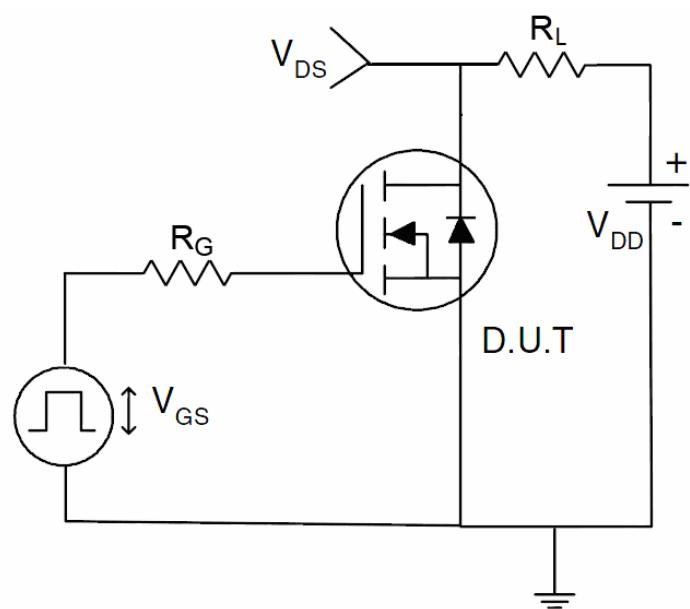
### 1) E<sub>AS</sub> test Circuit



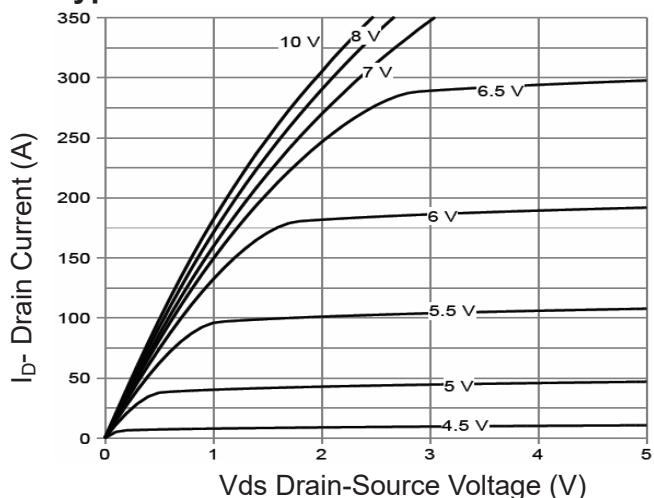
### 2) Gate charge test Circuit



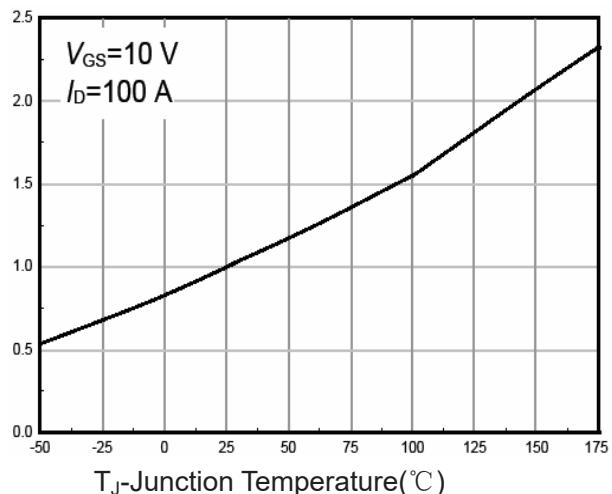
### 3) Switch Time Test Circuit



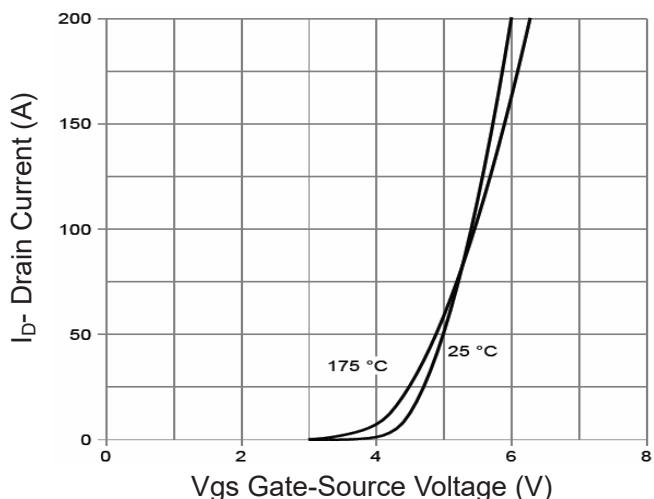
### Typical Electrical and Thermal Characteristics



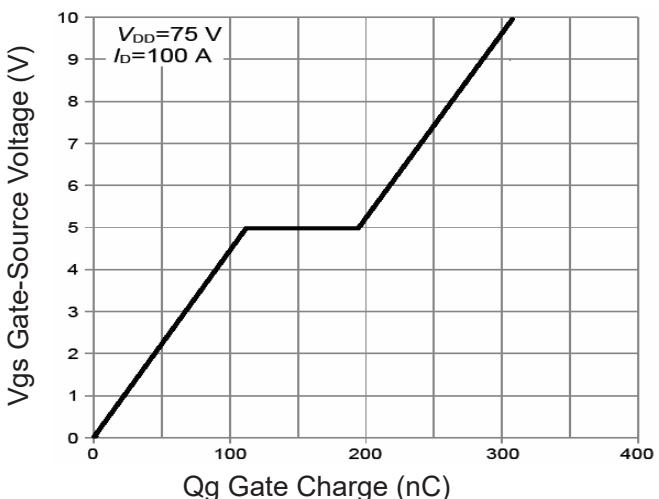
**Figure 1 Output Characteristics**



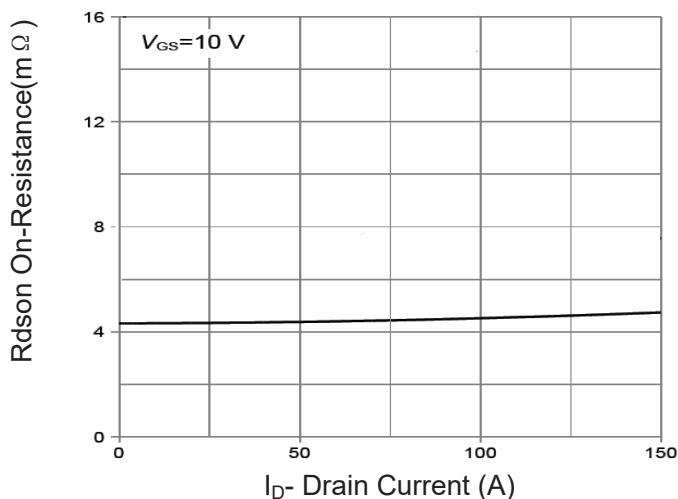
**Figure 4 Rdson-JunctionTemperature**



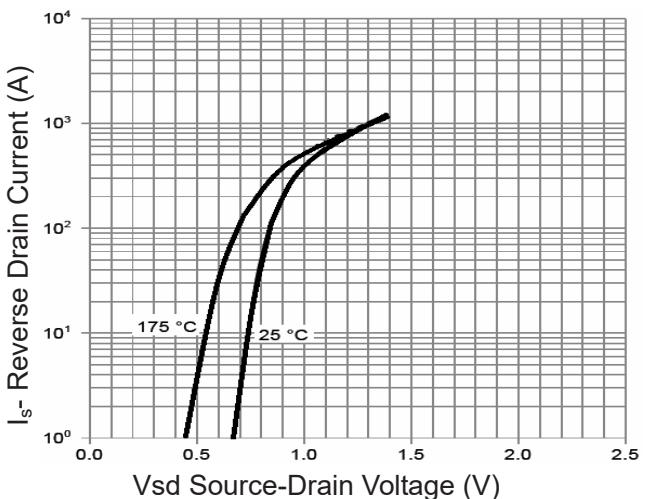
**Figure 2 Transfer Characteristics**



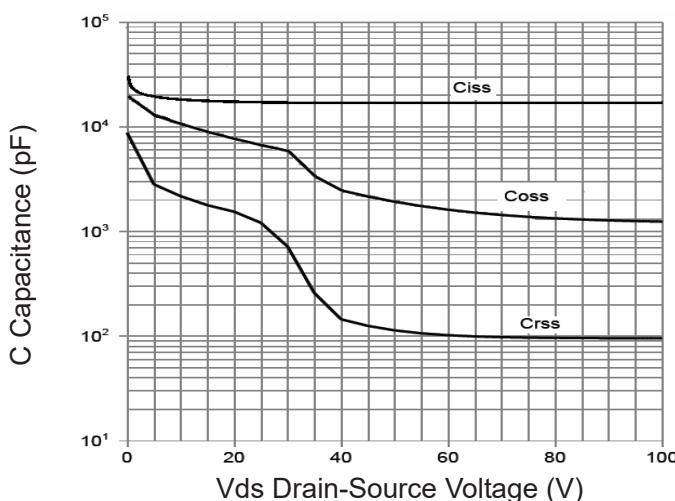
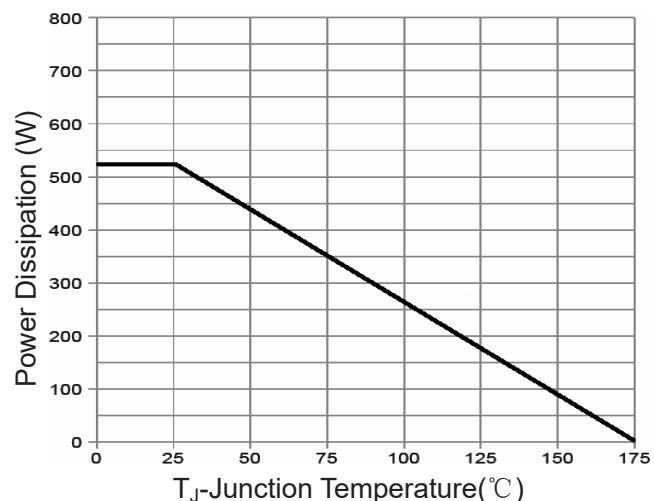
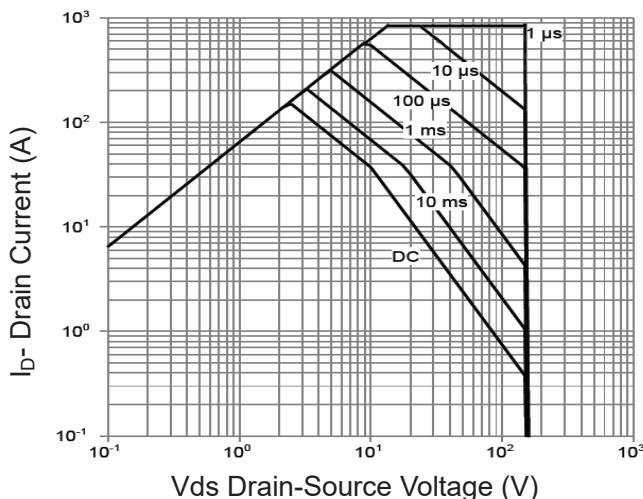
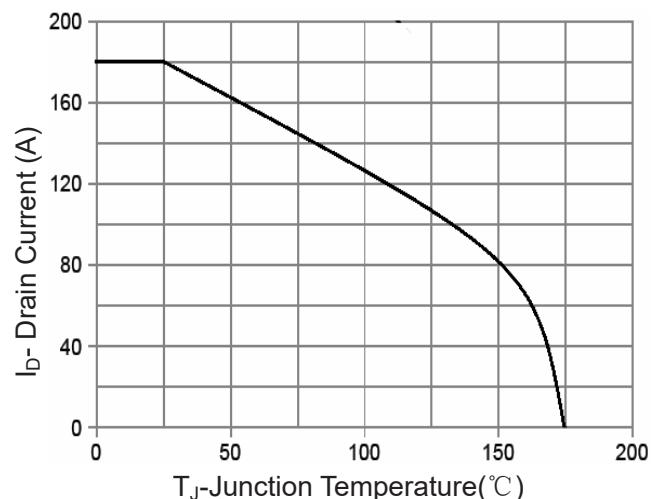
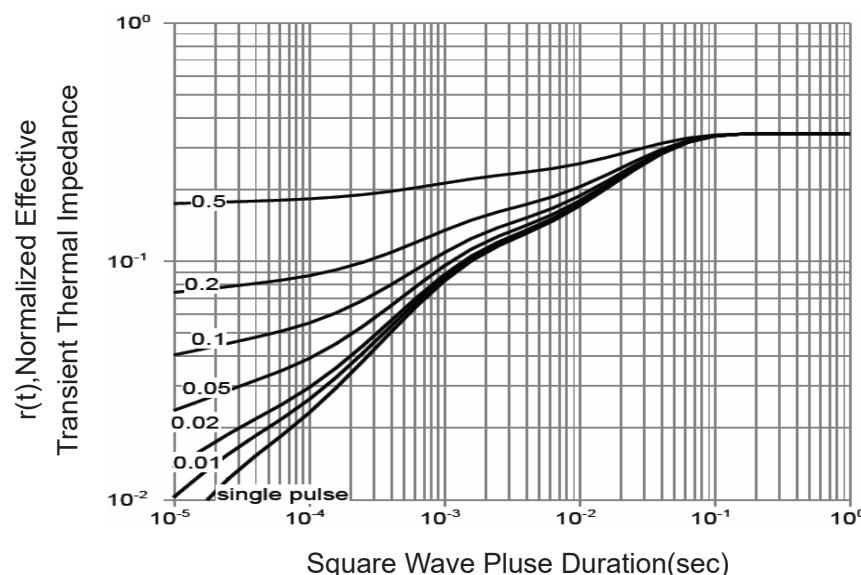
**Figure 5 Gate Charge**



**Figure 3 Rdson- Drain Current**



**Figure 6 Source- Drain Diode Forward**


**Figure 7 Capacitance vs Vds**

**Figure 9 Power De-rating**

**Figure 8 Safe Operation Area**

**Figure 10 Current De-rating**

**Figure 11 Normalized Maximum Transient Thermal Impedance**